



SUBSTITUTE SPECIFICATION

METHOD OF RECYCLING MOLD PLASTIC PARTS FOR PHOTSENSITIVE MATERIAL AND A RECYCLED PLASTIC MOLD PARTS

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This application is a Divisional of U.S. Patent Application No. 09/963,472 filed on September 27, 2001. The entire contents of the above-identified application is hereby incorporated by reference.

BACKGROUND OF THE INVENTION

1. Field of the Invention

The present invention relates to a method of recycling molded plastic parts for photosensitive material and to recycled plastic molded parts for photosensitive material.

2. Description Related to the Prior Art

Conventionally, molded plastic parts are used for example as a camera body of a lens-fitted photo film unit. The camera body contains a film cartridge as a photosensitive material, and simple photo mechanisms therein.

Almost all of the molded plastic parts of the camera body are used in order to pack the film cartridge in a light-tight fashion. Accordingly, they have ever been formed of a composition of thermoplastic resins. Hereafter, the molded plastic parts used for photosensitive material are simply called molded plastic parts.

The molded plastic parts must have following qualities